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**PATENT
IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Application of : Jorge A. Morando


For : **ALLOY COMPOSITION SUITABLE FOR
MOLTEN MAGNESIUM ENVIRONMENTS**

Serial No. : 09/535,550

Filed : March 27, 2000

Attorney Docket No. : MJV-120 A

Cleveland, Ohio 44114
June 13, 2000



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INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner of Patents
Washington, D.C. 20231

Dear Sir:

In accordance with 37 C.F.R. §§ 1.56, 1.97, 1.98 and MPEP § 609, applicant(s) submit(s) the following Disclosure Statement concerning art of which the applicant(s) is (are) aware. A copy of PTO-1449 is enclosed herewith.

This Information Disclosure Statement is not intended to constitute an admission that any patent, publication or other information referred to herein or submitted herewith is "prior art" for this invention unless specifically designated as such.

In accordance with 37 C.F.R. §1.97(g) and (h), the filing of this Information Disclosure Statement shall not be construed to mean that a search has been made or that no other material information as defined in 37 C.F.R. §1.56(b) exists.

Under § 1.98(a)(3), no concise explanation of relevance is required for information that is in the English language. Accordingly, the enclosed patent requires no further explanation (or no translation is available).

4,034,588 - Way et al.

4,236,920 - Lampe et al.

4,331,741 - Wilson

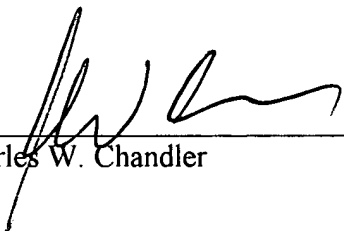
4,363,660 - Wakita et al.

4,435,226 - Neuhäuser et al.
4,487,630 - Crook et al.
4,560,408 - Wilhelmsson
4,727,740 - Yabuki et al.
4,880,461 - Uchida
5,077,006 - Culling
5,783,143 - Handa et. al.
PCT/JP82/00338 - Japan

Under § 1.97(b)(3), this information disclosure statement is being filed before the mailing date of a first Office Action on the merits. Although it is believed no fee is necessary, any deficiency in fees should be charged to Deposit Account No. 06-0308.

It is respectfully requested that the attached document(s) be considered and officially cited in examination of this application.

Respectfully submitted,



Charles W. Chandler

I hereby certify that this correspondence is being deposited
with the United States Postal Service as first class mail in
an envelope addressed to Assistant Commissioner for
Patents, Washington, DC 20231, on 6/28/00



(SIGNATURE)